NSN 3670-01-255-3269

Printed Circuit Board Laminating Machine - Page 1 of 1



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Bonder autoclave system

General Description:

Operates under control temperatures of up to 700 degrees f and pressures up to 300 psig for composite bonding, glass laminating and rubber curing; vessel workspace 13.000 in. Sq by 36.000 in. L; 2 door assemblies; horizontal loading; vessel shell i.D. 22.600 in.; nitrogen or air pressurizing medium

		ife:	

N/a

Unit Of Measure:

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Demilitarization:

No

Fiig:

A23900